

# MC74LV594A

## 8-Bit Shift Register with Output Register

The MC74LV594A is an 8-bit shift register designed for 2 V to 6.0 V  $V_{CC}$  operation. The device contains an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. Separate clocks (RCLK, SRCLK) and direct overriding clear ( $\overline{RCLR}$ ,  $\overline{SRCLR}$ ) inputs are provided on the shift and storage registers. A serial output ( $Q_H$ ) is provided for cascading purposes.

The shift-register (SRCLK) and storage-register (RCLK) clocks are positive-edge triggered. If the clocks are tied together, the shift register always is one clock pulse ahead of the storage register.

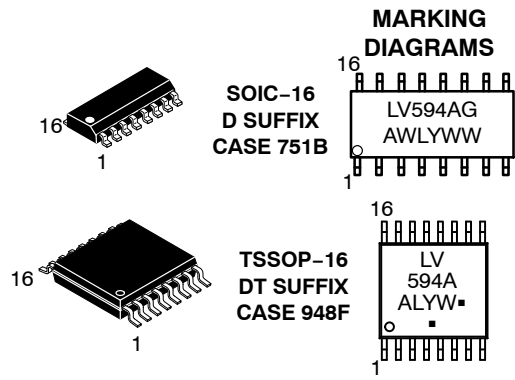
### Features

- 2.0 V to 6.0 V  $V_{CC}$  Operation
- Low Input Current: 1.0  $\mu$ A
- Max  $t_{pd}$  of 6.5 ns at 5 V
- Typical  $V_{OLP}$  (Output Ground Bounce) < 0.8 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot) > 2.3 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Support Mixed-Mode Voltage Operation on All Ports
- 8-Bit Serial-In, Parallel-Out Shift Registers With Storage
- Independent Direct Overriding Clears on Shift and Storage Registers
- Independent Clocks for Shift and Storage Registers
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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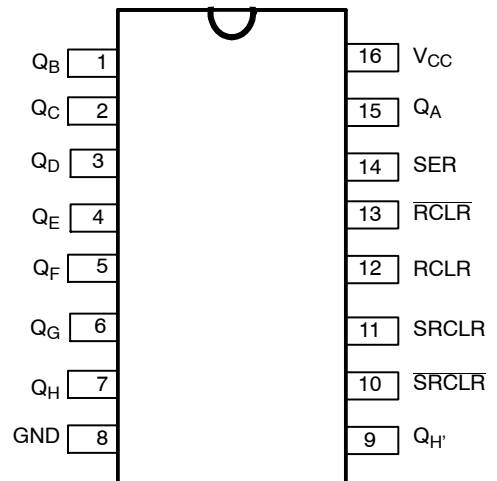
<http://onsemi.com>



A = Assembly Location  
 WL, L = Wafer Lot  
 YY, Y = Year  
 WW, W = Work Week  
 G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

### PIN ASSIGNMENT



### ORDERING INFORMATION

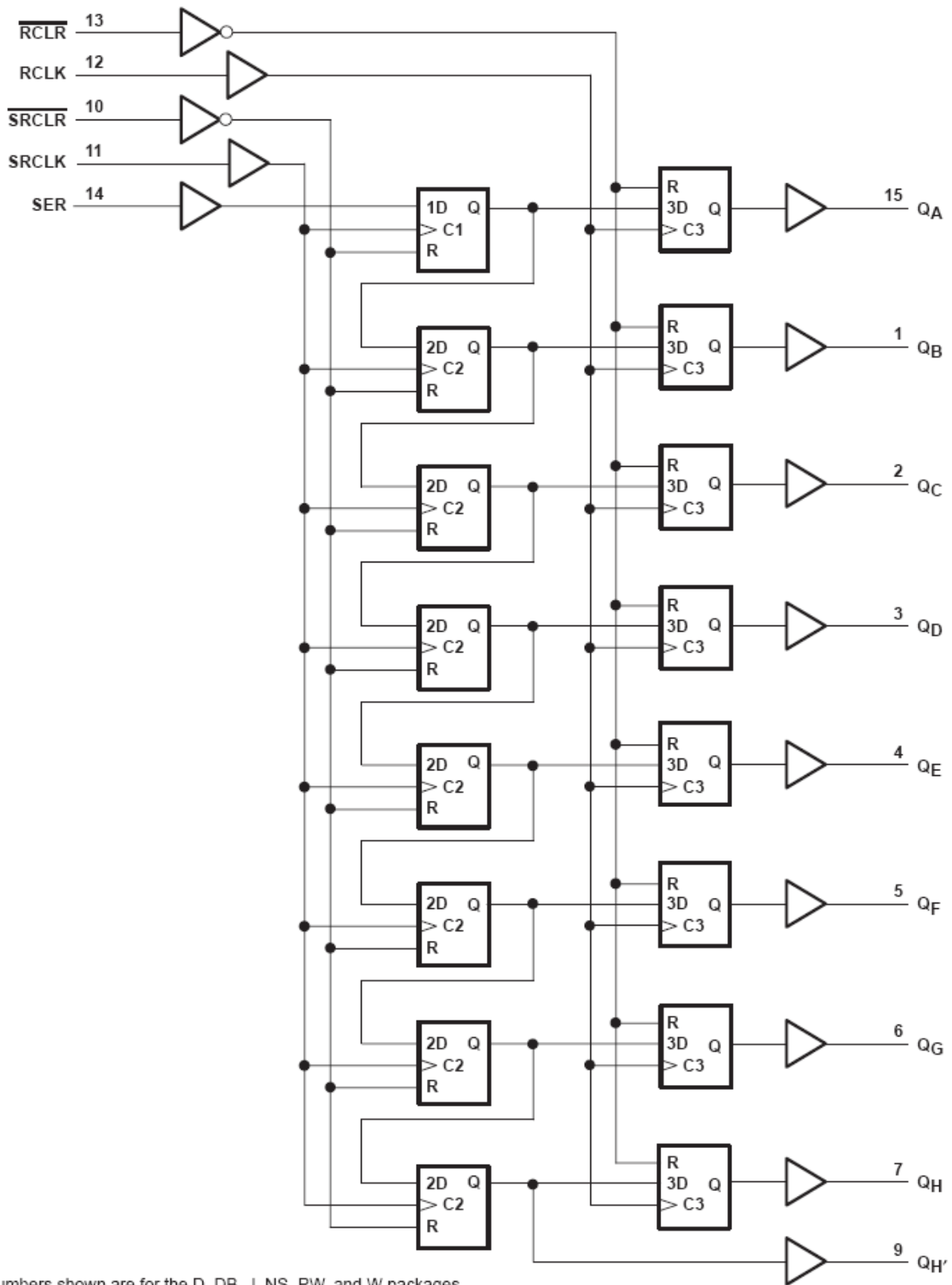
See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

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FUNCTION TABLE

INPUTS					FUNCTION
SER	SRCLK	$\overline{\text{SRCLR}}$	RCLK	$\overline{\text{RCLR}}$	
X	X	L	X	X	Shift register is cleared.
L	↑	H	X	X	First stage of shift register goes low. Other stages store the data of previous stage, respectively.
H	↑	H	X	X	First stage of shift register goes high. Other stages store the data of previous stage, respectively.
L	↓	H	X	X	Shift register state is not changed.
X	X	X	X	L	Storage register is cleared.
X	X	X	↑	H	Shift register data is stored in the storage register.
X	X	X	↓	H	Storage register state is not changed.

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numbers shown are for the D, DB, J, NS, PW, and W packages.

**Figure 1. Logic Diagram**

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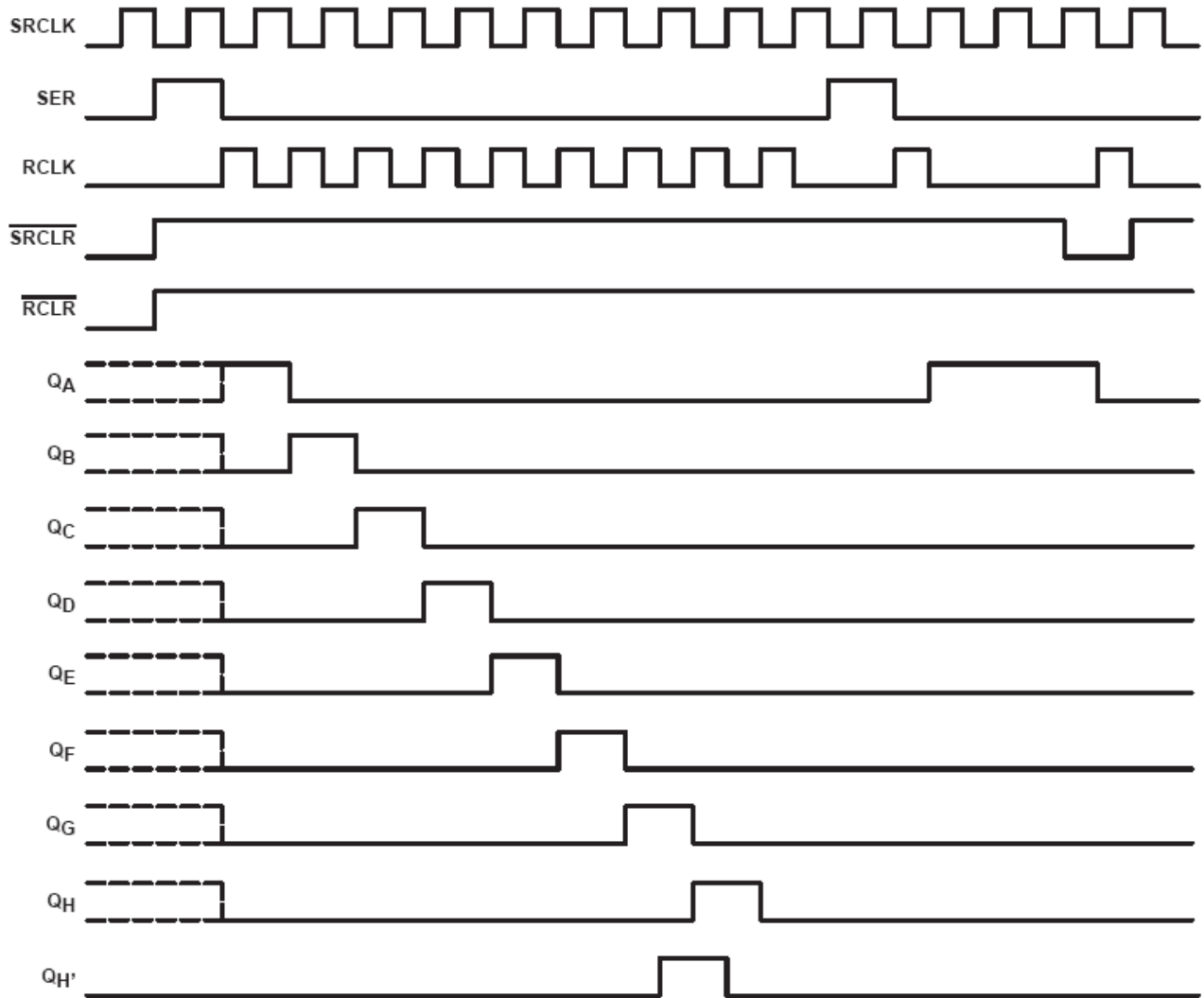


Figure 2. Timing Diagram

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MC74LV594ADR2G	SOIC-16 (Pb-Free)	2500 / Tape & Reel
MC74LV594ADTR2G	TSSOP-16* (Pb-Free)	2500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*This package is inherently Pb-Free.

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## MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{CC}$	DC Supply Voltage	-0.5 to +7.0	V
$V_I$	DC Input Voltage	-0.5 to $V_{CC} + 0.5$	V
$V_O$	DC Output Voltage Active Mode (Note 1)	-0.5 to $V_{CC} + 0.5$	V
	High Impedance or Power-Off Mode	-0.5 to +7.0	
$I_{IK}$	DC Input Clamp Current	$\pm 20$	mA
$I_{OK}$	DC Output Clamp Current	$\pm 35$	mA
$I_{IN}$	DC Input Current	$\pm 20$	mA
$I_O$	DC Output Source / Sink Current	$\pm 35$	mA
$I_{CC}$	DC Supply Current per Supply Pin	$\pm 75$	mA
$I_{GND}$	DC Ground Current per Ground Pin	$\pm 75$	mA
$T_{STG}$	Storage Temperature Range	-65 to +150	$^{\circ}C$
$T_L$	Lead temperature, 1 mm from Case for 10 Seconds	260	$^{\circ}C$
$T_J$	Junction temperature under Bias	+150	$^{\circ}C$
$\theta_{JA}$	Thermal Resistance SOIC TSSOP	112 148	$^{\circ}C$
$P_D$	Power Dissipation in Still Air at SOIC TSSOP	500 450	mW
MSL	Moisture Sensitivity	Level 1	
$F_R$	Flammability Rating Oxygen Index: 30% - 35%	UL-94-V0 (0.125 in)	
$V_{ESD}$	ESD Withstand Voltage Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	> 3000 >400 N/A	V
$I_{Latchup}$	Latchup Performance Above $V_{CC}$ and Below GND at 85 $^{\circ}C$ (Note 5)	$\pm 300$	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1.  $I_O$  absolute maximum rating must be observed.
2. Tested to EIA/JESD22-A114-A.
3. Tested to EIA/JESD22-A115-A.
4. Tested to JESD22-C101-A.
5. Tested to EIA/JESD78.
6. For high frequency or heavy load considerations, see the ON Semiconductor High-Speed CMOS Data Book (DL129/D).

## RECOMMENDED OPERATING CONDITIONS (Note 7)

Symbol	Parameter	Min	Max	Unit
$V_{CC}$	DC Supply Voltage (Referenced to GND)	2.0	6.0	V
$V_I$	DC Input Voltage (Referenced to GND)	0	$V_{CC}$	V
$V_O$	DC Output Voltage (Referenced to GND)	0	$V_{CC}$	V
$T_A$	Operating Free-Air Temperature	-55	+125	$^{\circ}C$
$t_r, t_f$	Input Rise or Fall Rate $V_{CC} = 2.0$ V $V_{CC} = 4.5$ V $V_{CC} = 6.0$ V	0 0 0	1000 500 400	nS

7. All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation.

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## DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Guaranteed Limits					Unit
				T <sub>A</sub> = 25°C			T <sub>A</sub> = -55°C to 125°C		
				Min	Typ	Max	Min	Max	
V <sub>IH</sub>	Minimum High-Level Input Voltage		2.0	1.5			1.5		V
			2.3 – 6.0	0.7 x V <sub>CC</sub>			0.7 x V <sub>CC</sub>		
V <sub>IL</sub>	Maximum Low-Level Input Voltage		2.0			0.5		0.5	V
			2.3 – 6.0			0.3 x V <sub>CC</sub>		0.3 x V <sub>CC</sub>	
V <sub>OH</sub>	Minimum High-Level Output Voltage	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>							V
		I <sub>oH</sub> = -50 μA	2.0 – 6.0	V <sub>CC</sub> - 0.1			V <sub>CC</sub> - 0.1		
		I <sub>oH</sub> = -2 mA	2.3	2			2		
		I <sub>oH</sub> = -6 mA	3.0	2.48			2.48		
		I <sub>oH</sub> = -12 mA	4.5	3.8			3.8		
V <sub>OL</sub>	Maximum Low-Level Output Voltage	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>							V
		I <sub>oH</sub> = 50 μA	2.0 – 6.0			0.1		0.1	
		I <sub>oH</sub> = 2 mA	2.3			0.4		0.4	
		I <sub>oH</sub> = 6 mA	3.0			0.44		0.44	
		I <sub>oH</sub> = 12 mA	4.5			0.55		0.55	
I <sub>IN</sub>	Maximum Input Leakage Current	V <sub>I</sub> = V <sub>CC</sub> or GND	6.0		±0.1		±1		μA
I <sub>CC</sub>	Maximum Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 A	6.0			8.0		80	μA
C <sub>I</sub>	Input Capacitance	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3		3.5				pF

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## TIMING SPECIFICATIONS (See Figure 3)

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = 25°C		T <sub>A</sub> = -55°C to 125°C		Unit			
				Min	Max	Min	Max				
t <sub>w</sub>	Pulse Duration	RCLK or SRCLK High or Low	2.3 – 2.7	7		7.5		ns			
			3.0 – 3.6	5.5		5.5					
			4.5 – 5.5	5		5					
		RCLR or SRCLR Low	2.3 – 2.7	6		6.5					
			3.0 – 3.6	5		5					
			4.5 – 5.5	5.2		5.2					
t <sub>su</sub>	Setup Time	SER before SRCLK↑	2.3 – 2.7	5.5		5.5		ns			
			3.0 – 3.6	3.5		3.5					
			4.5 – 5.5	3		3					
		SRCLK↑ before RCLK↑	2.3 – 2.7	8		9					
			3.0 – 3.6	8		8.5					
			4.5 – 5.5	5		5					
		SRCLR Low before RCLK↑	2.3 – 2.7	8.5		9.5					
			3.0 – 3.6	8		9					
			4.5 – 5.5	5		5					
		SRCLR High (Inactive) before SRCLK↑	2.3 – 2.7	6		6.8					
			3.0 – 3.6	4.2		4.8					
			4.5 – 5.5	2.9		3.3					
		RCLR High (Inactive) before RCLK↑	2.3 – 2.7	6.7		7.6					
			3.0 – 3.6	4.6		5.3					
			4.5 – 5.5	3.2		3.7					
		t <sub>H</sub>	Hold Time	SER after SRCLK↑	2.3 – 2.7	1.5			1.5		ns
					3.0 – 3.6	1.5			1.5		
					4.5 – 5.5	2			2		

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## AC CHARACTERISTICS (See Figure 3)

Symbol	Parameter	Load Conditions	Input to Output	V <sub>CC</sub> (V)	Guaranteed Limits					Unit
					T <sub>A</sub> = 25°C			T <sub>A</sub> = -55°C to 125°C		
					Min	Typ	Max	Min	Max	
f <sub>MAX</sub>		C <sub>L</sub> = 15 pF		2.3 – 2.7	65	80		45		MHz
				3.0 – 3.6	80	120		70		
				4.5 – 5.5	135	170		115		
		C <sub>L</sub> = 50 pF		2.3 – 2.7	50	51		40		
				3.0 – 3.6	70	74		55		
				4.5 – 5.5	115	120		90		
t <sub>PLH</sub>	Propagation Delay Low to High	C <sub>L</sub> = 15 pF	RCLK to Q <sub>A</sub> -Q <sub>H</sub>	2.3 – 2.7			27.5	1	32.5	ns
				3.0 – 3.6			18	1	22.5	
				4.5 – 5.5			12	1	15	
			SRCLK to Q <sub>H</sub> '	2.3 – 2.7			27.5	1	32	
				3.0 – 3.6			18	1	22	
				4.5 – 5.5			12.5	1	12	
		C <sub>L</sub> = 50 pF	RCLK to Q <sub>A</sub> -Q <sub>H</sub>	2.3 – 2.7		22.1	25.0	1	30.0	
				3.0 – 3.6		15.6	17.5	1	21.0	
				4.5 – 5.5		11.5	12.5	1	15.5	
			SRCLK to Q <sub>H</sub> '	2.3 – 2.7		21.6	25.5	1	29.5	
				3.0 – 3.6		15.2	18.0	1	21.0	
				4.5 – 5.5		10.9	12.5	1	15.0	
t <sub>PHL</sub>	Propagation Delay High to Low	C <sub>L</sub> = 15 pF	RCLK to Q <sub>A</sub> -Q <sub>H</sub>	2.3 – 2.7			23	1	27.5	ns
				3.0 – 3.6			15.5	1	19	
				4.5 – 5.5			11	1	14	
			SRCLK to Q <sub>H</sub> '	2.3 – 2.7			23.5	1	27	
				3.0 – 3.6			16	1	19	
				4.5 – 5.5			11	1	13.5	
			RCLR to Q <sub>A</sub> -Q <sub>H</sub>	2.3 – 2.7			20.5	1	25	
				3.0 – 3.6			14.5	1	17.5	
				4.5 – 5.5			10	1	12	
			SRCLR to Q <sub>H</sub> '	2.3 – 2.7				1	23	
				3.0 – 3.6			13	1	16	
				4.5 – 5.5			9	1	11	
		C <sub>L</sub> = 50 pF	RCLK to Q <sub>A</sub> -Q <sub>H</sub>	2.3 – 2.7		19.7	23.0	1	27.0	
				3.0 – 3.6		14.0	16.5	1	19.5	
				4.5 – 5.5		10.1	11.5	1	13.5	
			SRCLK to Q <sub>H</sub> '	2.3 – 2.7		18.4	21.5	1	25.0	
				3.0 – 3.6		13.1	15.0	1	18.0	
				4.5 – 5.5		9.0	10.5	1	12.5	
			RCLR to Q <sub>A</sub> -Q <sub>H</sub>	2.3 – 2.7		25.7	30.0	1	35.0	
				3.0 – 3.6		17.6	20.0	1	24.5	
				4.5 – 5.5		12.2	13.5	1	17.0	
			SRCLR to Q <sub>H</sub> '	2.3 – 2.7		25.3	30.0	1	34	
				3.0 – 3.6		17.3	20.0	1	24.0	
				4.5 – 5.5		11.9	14.0	1	16.5	



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## NOISE CHARACTERISTICS, $V_{CC} = 3.3\text{ V}$ , $C_L = 50\text{ pF}$ , $T_A = 25^\circ\text{C}$

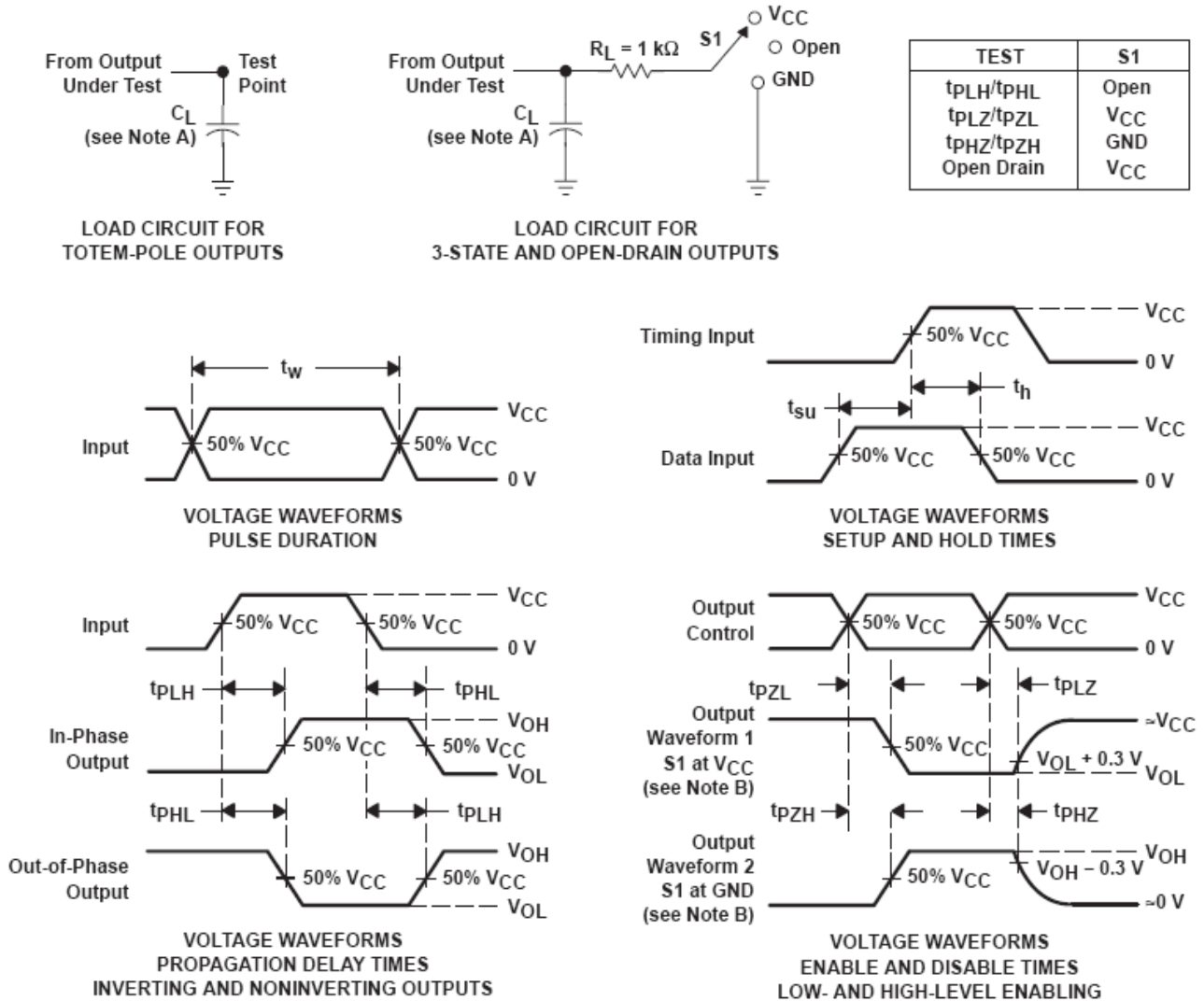
Symbol	Parameter	Min	Typ	Max	Unit
$V_{OL(P)}$	Quiet Output, Maximum Dynamic $V_{OL}$		0.8	0.8	V
$V_{OL(V)}$	Quiet Output, Minimum Dynamic $V_{OL}$		-0.1	-0.8	V
$V_{OH(V)}$	Quiet Output, Minimum Dynamic $V_{OH}$		2.8		V
$V_{IH(D)}$	High-Level Dynamic Input Voltage	2.31			V
$V_{IL(D)}$	Low-Level Dynamic Input Voltage			0.99	V

## POWER DISSIPATION CHARACTERISTICS, $T_A = 25^\circ\text{C}$

Symbol	Parameter	Test Conditions	$V_{CC}$ (V)	Typ	Unit
$C_{PD}$	Power Dissipation Capacitance	f = 10 MHz	3.3	93	pF
			5	112	

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## PARAMETER MEASUREMENT INFORMATION



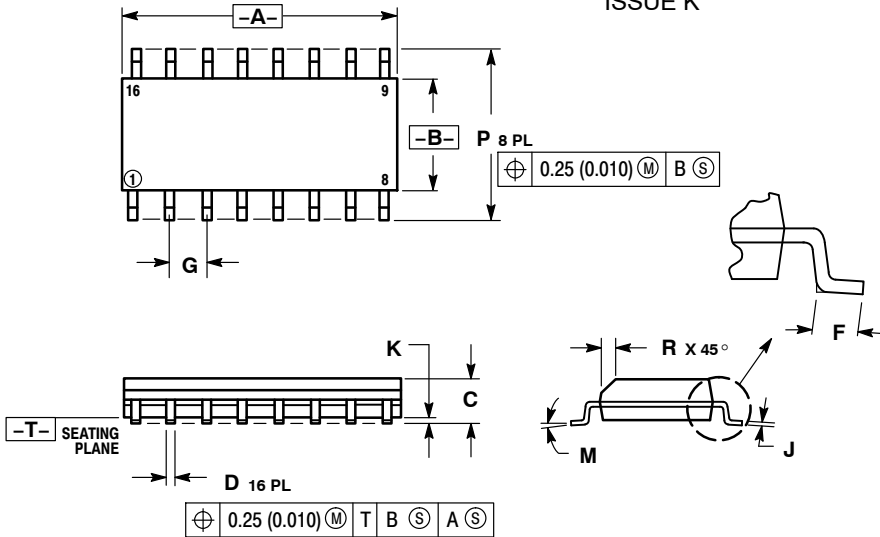
- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
  - D. The outputs are measured one at a time, with one input transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{pZL}$  and  $t_{pZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms

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## PACKAGE DIMENSIONS

SOIC-16  
CASE 751B-05  
ISSUE K

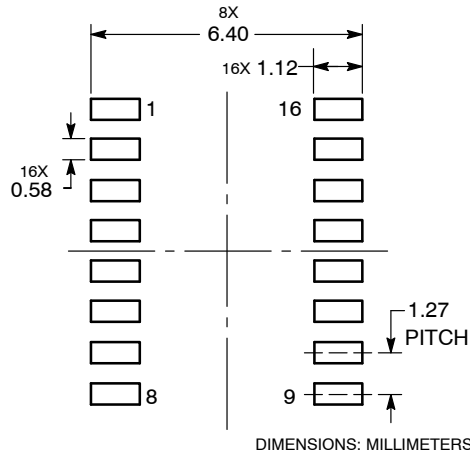


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

### SOLDERING FOOTPRINT\*

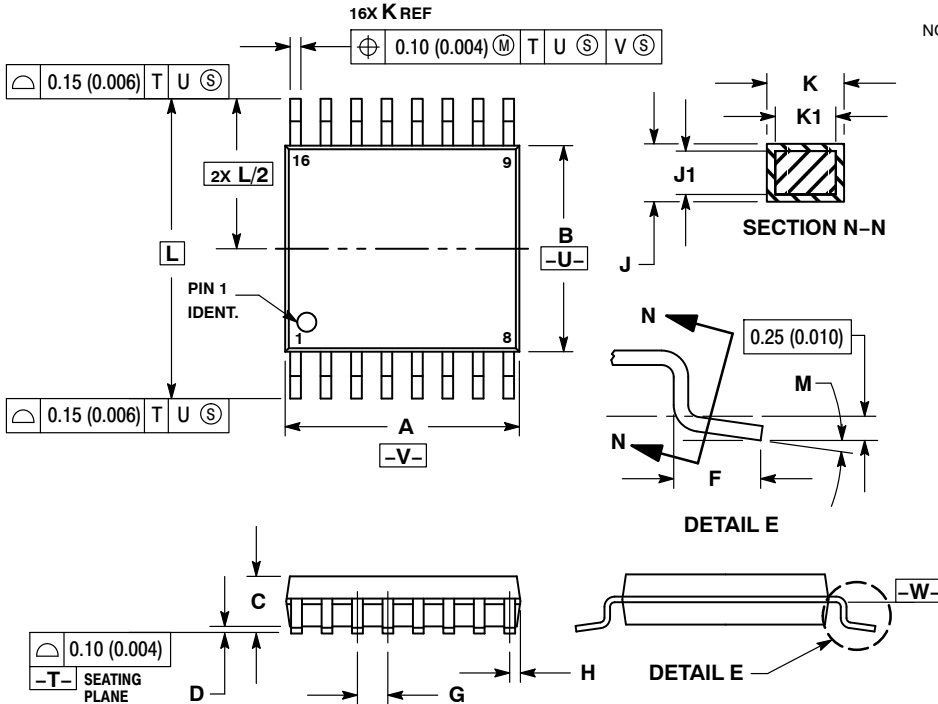


\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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## PACKAGE DIMENSIONS

TSSOP-16  
DT SUFFIX  
CASE 948F-01  
ISSUE B

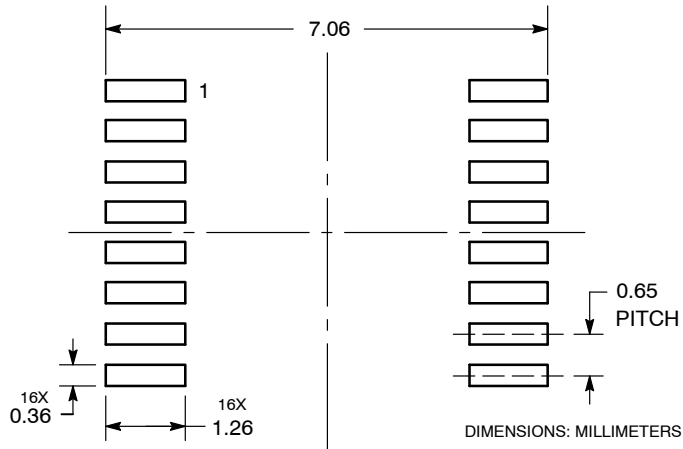


### NOTES:


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.18	0.28	0.007	0.011
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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